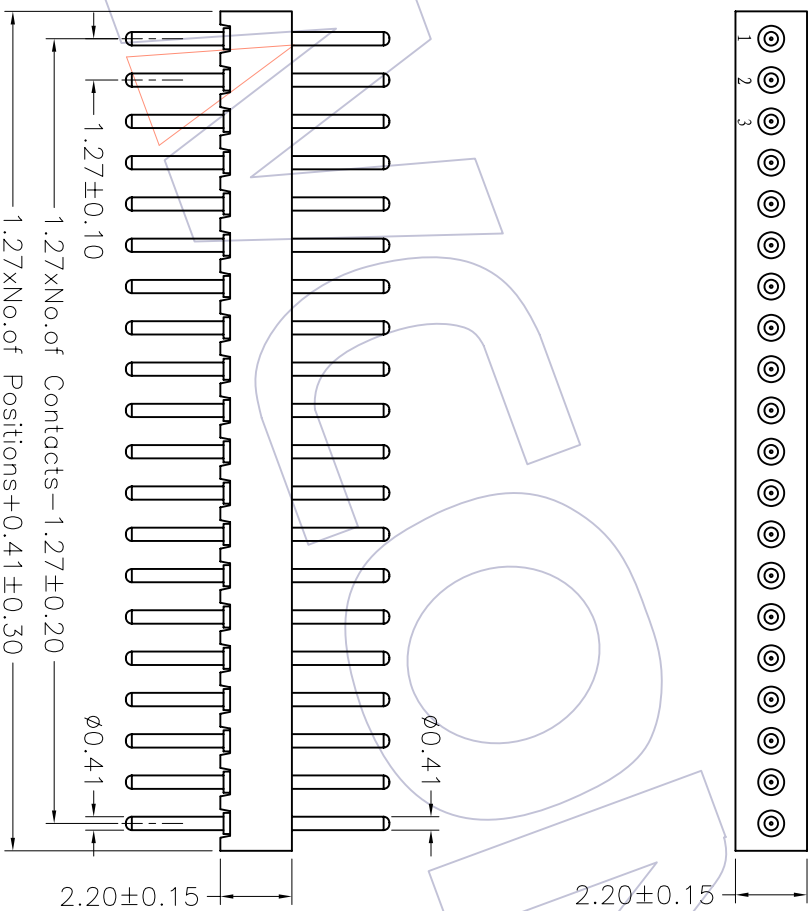
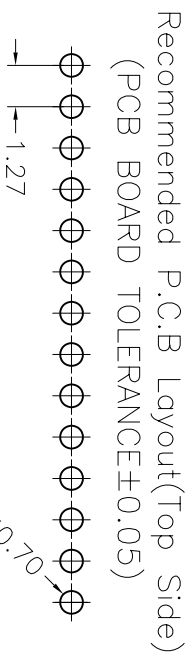


HSP

TECHNICAL SPECS:

Current Rating: 1.0AMP
 Contact Resistance: 10mΩ Max
 Dielectric Strength: Min 1000V/RMS
 Mechanical Life: Min 500 cycles
 Operation Temperature: -40°C to +105°C

Sleeve: Brass CuZn36Pb3(C360000)
 Connecting Pin: $\phi 0.41$ mm
 Contact plating: Au or Sn over Ni
 Insulator Material: PPS+30%G.F(UL94V-0)



Ordering Information

3514-221 XX S XX 081 X 1

- No. of Pin: 2-50PIN
- Contact Plating:
 G0=Gold Flash
 G1=3u"Gold
 G2=5u"Gold
 G3=10u"Gold
 G4=15u"Gold
 G5=30u"Gold
 S0=Gold Flash/Tin
 S1=3u"Gold/Tin
 S2=5u"Gold/Tin
 S3=10u"Gold/Tin
 S4=15u"Gold/Tin
 S5=30u"Gold/Tin
 SN=Tin
- Packing:
 A=Tray
 T=Tube

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	WEIXD	SCALE	PART NO.	TITLE:
A0	08/10/17	NEW			X.X ± 0.30	DESIGN	08/10/17	1:1	3514-221XXSX081X1	1.27mm MACHINED PIN HEADER SINGLE ROW 180° H=2.20 L=8.1
					X.XX ± 0.20	CHECK		A4		
					X.XXX ± 0.10	APPROVE		1/1		
					Angle $\pm 3'$	PROU.			Customer NO.	

WCON 维峰五金电子有限公司
 WAFER HARDWARE ELECTRONICS CO.,LTD